



## 40V N-Channel Trench Power MOSFET

### General Description

The SJP40N110 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

### Features

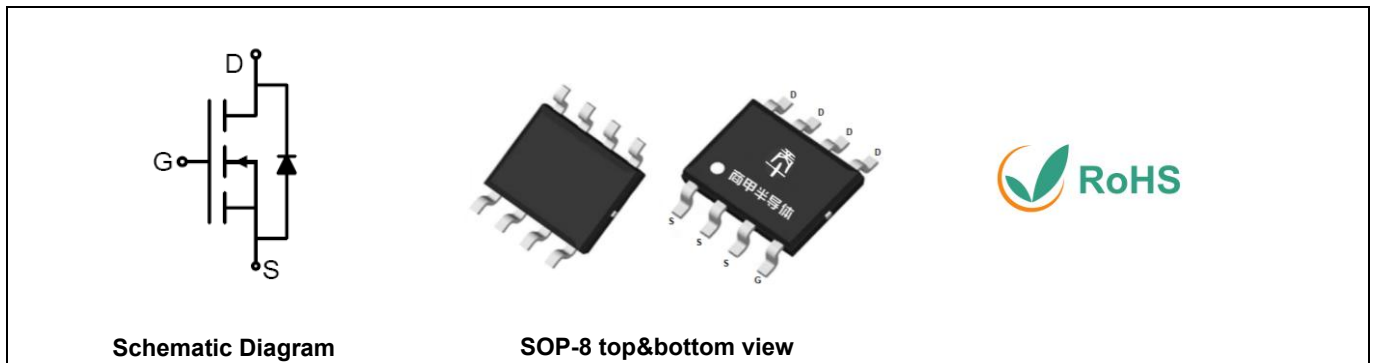
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	40	V
$R_{DS(ON\_TYP)}$	13.1	m $\Omega$
$I_D$	7.1	A
$Q_G$	21	nC



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJP40N110	SJP40N110	SOP-8	Tape	\	\	4000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	40	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ\text{C}$ )	7.1	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	4.5	A
$I_{DM (pluse)}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	28.4	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ\text{C}$ )	1.4	W
	Maximum Power Dissipation( $T_A=100^\circ\text{C}$ )	0.6	W
$E_{AS}$	Avalanche energy (Note 2)	56	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		90	$^\circ\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V, T_J=25^\circ\text{C}$			1	$\mu A$
		$V_{DS}=40V, V_{GS}=0V, T_J=125^\circ\text{C}$			100	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1		2.5	V
$g_{FS}$	Forward Transconductance	$V_{DS}=5V, I_D=15A$		26		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=15A, T_J=25^\circ\text{C}$		13.1	16.4	m $\Omega$
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=4.5V, I_D=10A, T_J=25^\circ\text{C}$		15.7	20.9	m $\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, f=1.0\text{MHz}$		950		pF
$C_{oss}$	Output Capacitance			79		pF
$C_{rss}$	Reverse Transfer Capacitance			67		pF
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$		2.3		$\Omega$
<b>Switching Parameters</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=10V, V_{DS}=20V, R_L=1.3\Omega, R_{GEN}=3\Omega$		15		nS
$t_r$	Turn-on Rise Time			22		nS
$t_{d(off)}$	Turn-Off Delay Time			35		nS
$t_f$	Turn-Off Fall Time			24		nS
$Q_g$	Total Gate Charge	$V_{GS}=10V, V_{DS}=20V, I_D=15A$		21		nC
$Q_{gs}$	Gate-Source Charge			3.5		nC
$Q_{gd}$	Gate-Drain Charge			5		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-Drain Current (Body Diode)				7.1	A
$V_{SD}$	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=15A$			1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F=15A, dI/dt=100A/\mu s$		19.5		ns
$Q_{rr}$	Reverse Recovery Charge	$I_F=15A, dI/dt=100A/\mu s$		17		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

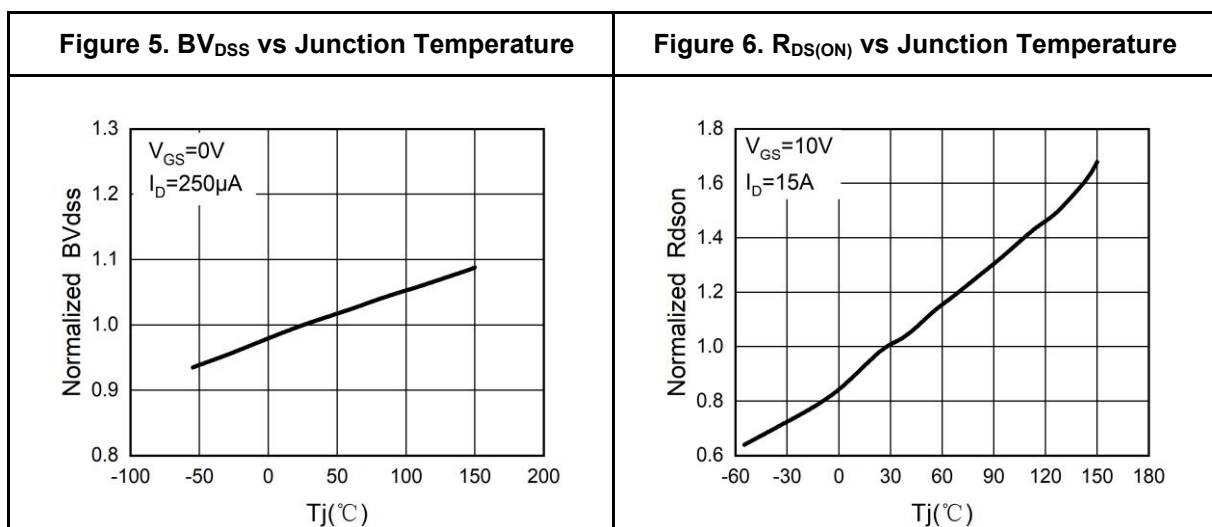
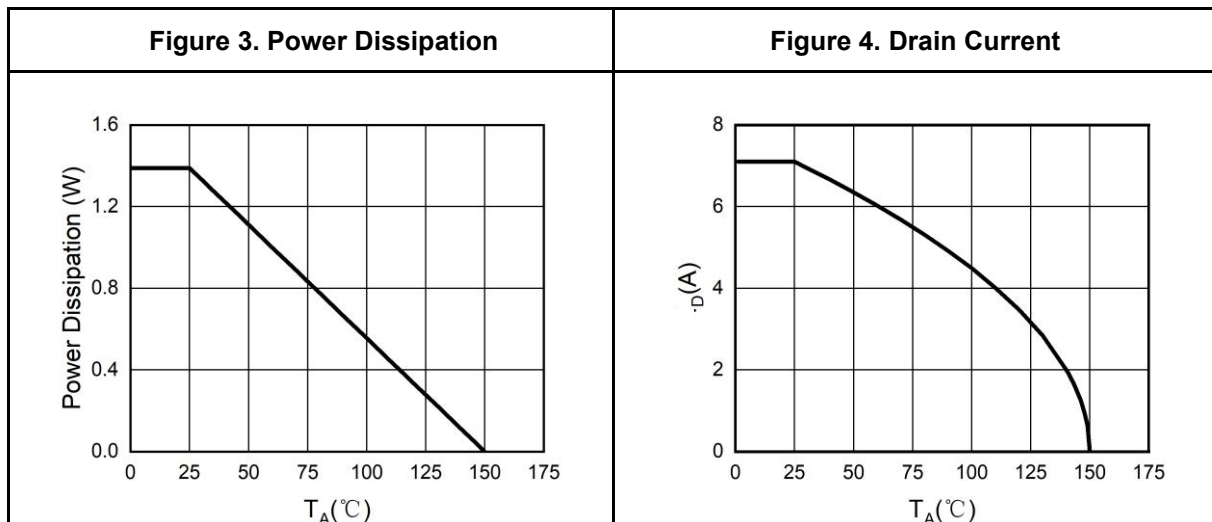
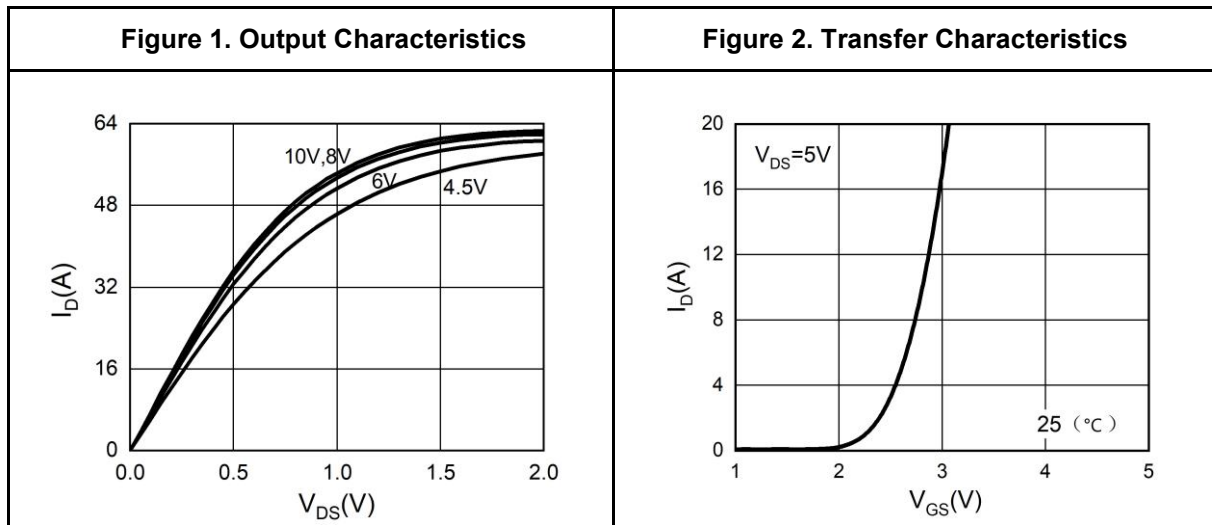
Notes 2.EAS condition:  $T_J=25^\circ\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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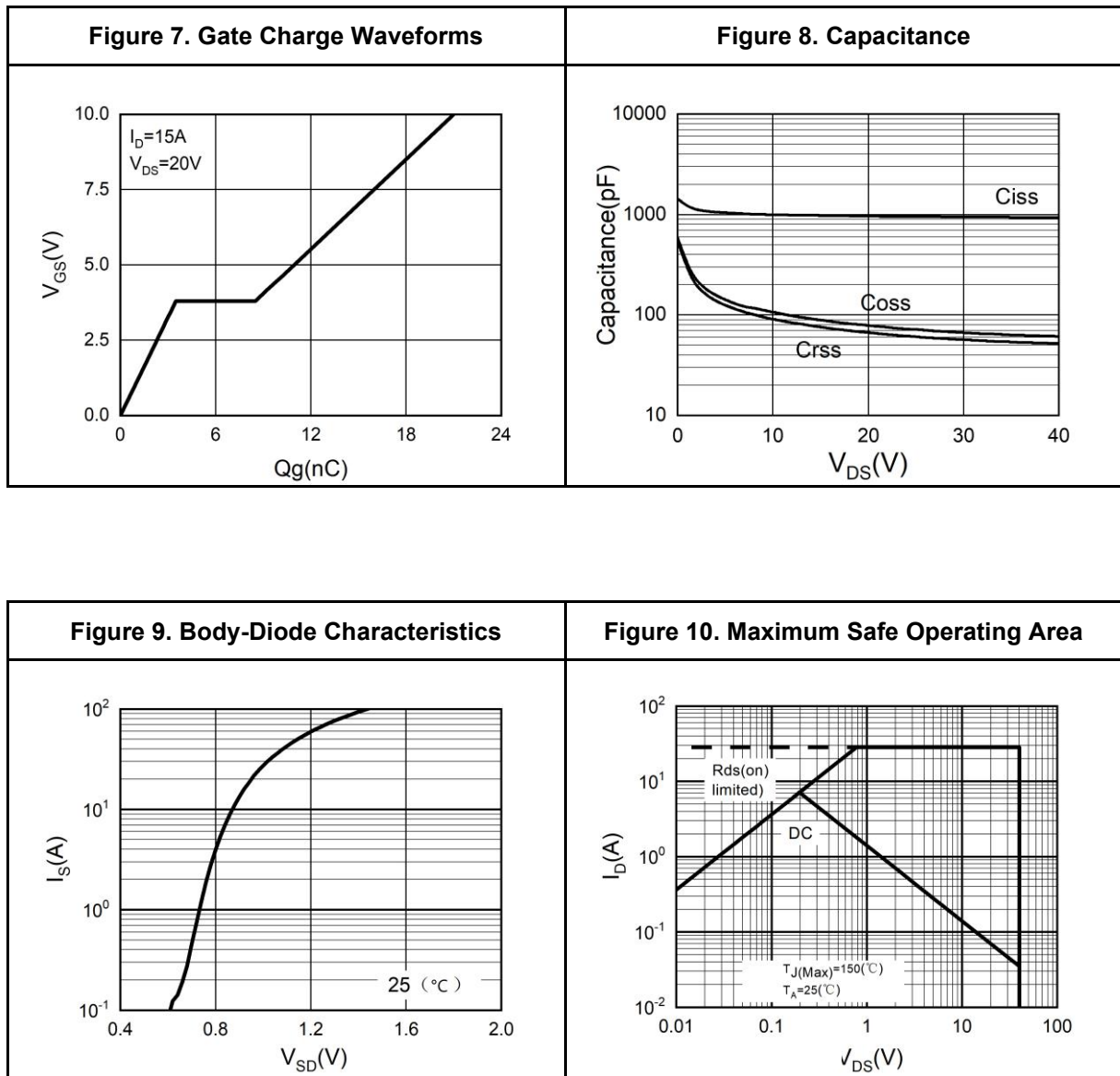
## Typical Electrical And Thermal Characteristics (Curves)





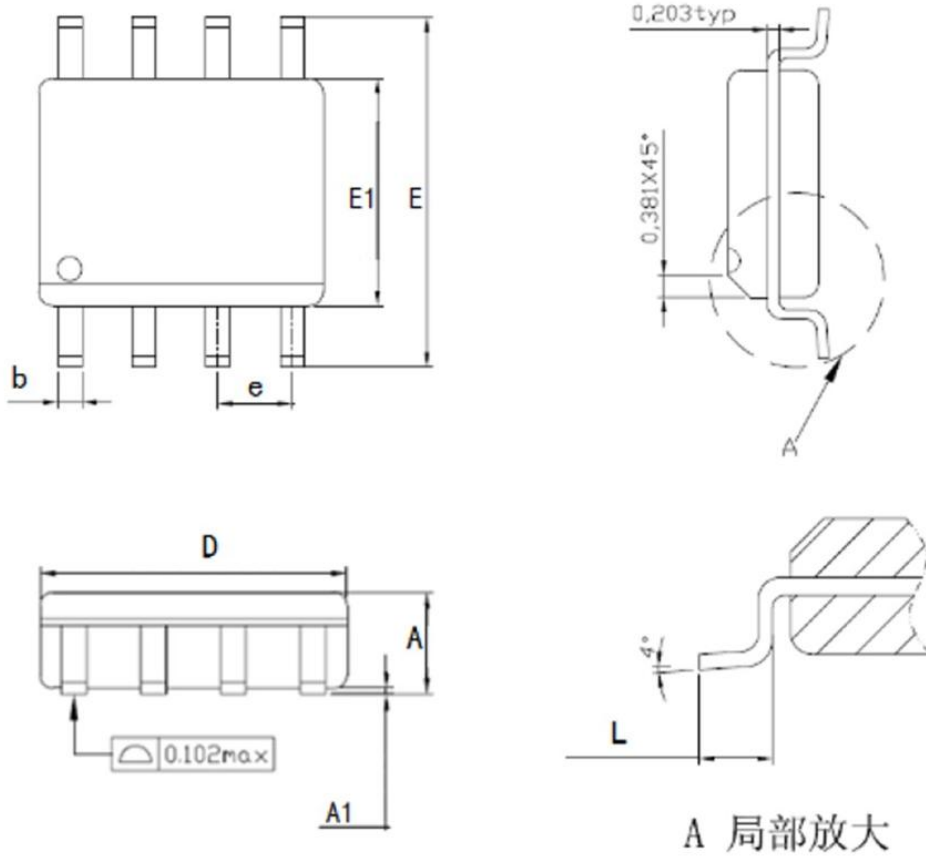
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## Typical Electrical And Thermal Characteristics (Curves)





SOP-8 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max
A	1.35	1.55	1.75
A1	0.1	0.15	0.2
b	0.346	0.406	0.466
D	4.8	4.89	4.98
E	5.75	6.00	6.25
E1	3.81	3.90	3.99
e	1.27TYP		
L	0.406	0.838	1.27



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